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# DOCUMENT NUMBER AND REVISION FS-8815P02042 REV. E (SFGL2WHES-12-RA-HDC)

# DOCUMENT TITLE: SPECIFICATION OF LCD MODULE TYPE

CUSTOMER	
MODEL NUMBER	8815P02042
CUSTOMER APPROVAL	
DATE	

DEPARTMENT	NAME	SIGNATURE	DATE
PREPARED BY	LIANG YUN		
CHECKED BY	ZHANG LIANG RONG		
APPROVED BY	WANG ZHAO CAI		

#### SHENZHEN JINGHUA DISPLAYS CO.,LTD.

No.511 Bldg.6.7/F., Bagualing Ind.District, Shenzhen, Guangdong Province, China

Fax: 86-755-82262610 URL: www.china-lcd.com



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#### **DOCUMENT REVISION HISTORY 1:**

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			1)(Page 6)The table 2 was updated.	YUN	LIANG RONG
D	C	2011 10 11	T. 1 1 1	LIANG	ZHANG
В	C	2011.10.11	Items 1 were updated. 1)(Page 12)The reset timing was	LIANG YUN	ZHANG LIANG RONG
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# Specification of LCD Module Type Item No.: 8815P02042

#### 1. General Description

- 240 x 128 Dots STN grey Positive Transflective Dot Matrix LCD Module.
- Viewing Angle: 12 O'clock direction.
- Driving duty: 1/128 Duty, 1/12 bias.
- RA6963C LCD Controller or equivalent. (SMT)
- SDN8080G Driver or equivalent. (COB)
- Power Supply: +5.0V.
- DC-DC IC built in temperature compensation circuit.
- White backlight. (Side LED)

#### 2. Mechanical Specifications

The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

#### Table 1

Parameter	Specifications	Unit
Outline dimensions	144.0(L) x 104.0(W) x 14.3MAX(H)	mm
Viewing area	114.0 (L) x 64.0(W)	mm
Display format	240 x 128	dots
Dot size	$0.43(L) \times 0.43(W)$	mm
Dot spacing	$0.02(L) \times 0.02(W)$	mm
Dot pitch	$0.45(L) \times 0.45(W)$	mm



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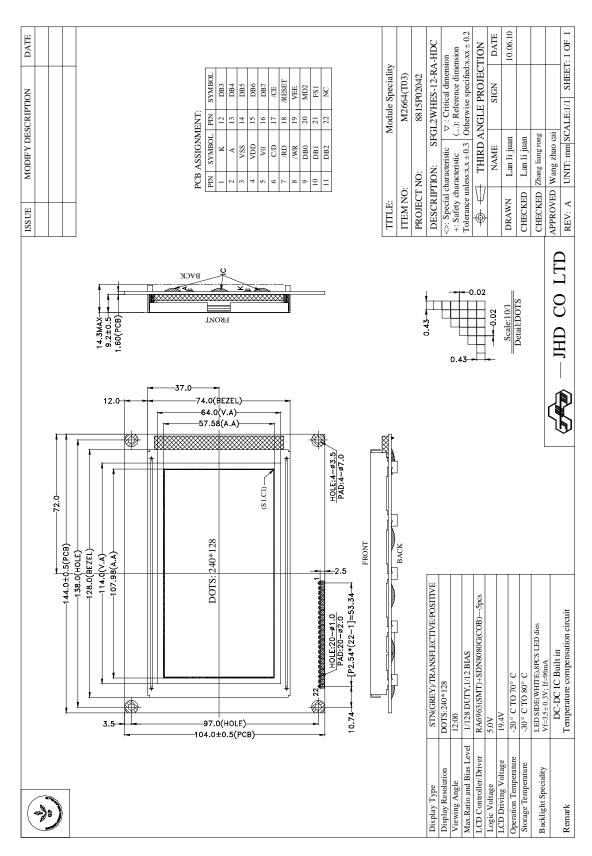


Figure 1: Module Specification



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# 3. Interface signals

# Table 2

1	Pin No.	Symbol		Description					
3	1	K	Cathode of th	Cathode of the backlight.					
A	2	A	Anode of the	Anode of the backlight.					
S	3	VSS	Ground. (0V)	Ground. (0V)					
Command/Data Select or Register Select	4	VDD	Power supply	11.4					
This is a Data or Command select signal.  C/D WR = Low RD = Low  High Command Write Status Read  Low Data Write Data Read  7 /RD Read Control RD is a data read signal. When Low, MPU read data from RA6963.  Write Control WR is a data write signal. When Low, MPU write data into RA6963.  9 DB0 Data bus. 10 DB1 Data bus. 11 DB2 Data bus. 12 DB3 Data bus. 13 DB4 Data bus. 14 DB5 Data bus. 15 DB6 Data bus. 16 DB7 Data bus.  Chip Enable  17 /CE This s chip enable of RA6963. When MPU communicate with RA696 this pin must be Low.  RESET Reset pin. There is a RC reset circuit inside.  Columns Selection (MD3 = High, inside)  Font Selection (FS0 = Low, inside)  FS0 H L H L FS1 H H L L FS1 H L H	5	V0	External bias	External bias voltage for LCD driver.					
C/D   WR = Low   RD = Low     High   Command Write   Status Read     Low   Data Write   Data Read     Read Control     RD is a data read signal. When Low, MPU read data from RA6963.     Write Control     WR is a data write signal. When Low, MPU write data into RA6963.     9			Command	/Data Sele	ect or Regi	ster Select			
High   Command Write   Status Read   Low   Data Write   Data Read			This is a Dat	a or Comn	nand select	signal.			
Low	6	C/D	C/ <b>D</b>	WR	= Low		RD = Lo	w	
Read Control   RD is a data read signal. When Low, MPU read data from RA6963.			High	Comm	and Write		Status Rea	ad	
RD is a data read signal. When Low, MPU read data from RA6963.   Write Control			Low	Dat	a Write		Data Rea	d	
RD is a data read signal. When Low, MPU read data from RA6963.   Write Control	7	/P.D.	Read Cont	Read Control					
WR is a data write signal. When Low, MPU write data into RA6963.   9	,	/ KD	RD is a data r	ead signal	When Lov	v, MPU rea	d data from	RA6963.	
WR is a data write signal. When Low, MPU write data into RA6963.   9	8	/WP	Write Con	trol					
10	O	/ <b>VV I</b> X	WR is a data	write signa	ıl. When Lo	ow, MPU w	rite data int	to RA6963.	
11	9	DB0	Data bus.						
12	10	DB1	Data bus.						
13	11	DB2	Data bus.						
14	12	DB3	Data bus.						
15	13	DB4	Data bus.						
16	14	DB5	Data bus.						
17	15	DB6	Data bus.						
This s chip enable of RA6963. When MPU communicate with RA696 this pin must be Low.	16	DB7	Data bus.						
this pin must be Low.    18			Chip Enal	ole					
18	17	/CE	This s chip e	nable of F	RA6963. W	hen MPU	communica	ate with RA6963,	
19   VEE   Power supply.     Columns Selection (MD3 = High, inside)     MD2   H			-						
Columns Selection (MD3 = High, inside)   MD2	18	/RESET	Reset pin. Th	ere is a RC	reset circu	it inside.			
20 MD2 H L H L  MD3 H H L L  Columns 32 40 64 80  Font Selection (FS0 = Low, inside)  FS0 H L H L  FS1 FS1 H H L L	19	VEE	Power supply	•					
20 MD2 MD3 H H L L Columns 32 40 64 80  Font Selection (FS0 = Low, inside)  FS0 H L H L FS1 FS1 H H L L			Columns Se	lection (I	MD3 = Hig	h, inside)		_	
MD3	20	MD2	MD2	Н	L	Н	L		
Font Selection (FS0 = Low, inside)  FS0	20	MID2	MD3	Н	Н	L	L		
21 FS1 FS0 H L H L FS1 H H L L			Columns	32	40	64	80		
21 FS1 FS1 H H L L			Font Selec	tion (FS	0 = Low, i	nside)			
FS1 H H L L	21	70.	FS0	Н	L	Н	L		
	21	FS1	FS1	Н	Н	L	L		
Font   5X8   6X8   7X8   8X8			Font	5 X 8	6 X 8	7 X 8	8 X 8		
22 NC No connection.	22	NC	No connection	n.					



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# 4. Absolute Maximum Ratings

# 4.1 Electrical Maximum Ratings (Ta = 25 °C)

#### Table 3

Parameter	Symbol	Min.	Max.	Unit
Power Supply voltage (Logic)	V <sub>DD</sub> (Note)	-0.3	+7.0	V
Input Voltage	V <sub>IN</sub> (Note)	-0.3	$V_{DD} + 0.3$	V

Note:

Referenced to  $V_{SS}$ =0V.

#### 4.2 Environmental Condition

#### Table 4

Item	Operating Temperature (Topr)		Storage Temperature (Tstg)		Remark
	Min.	Max.	Min.	Max.	
Ambient Temperature	-20°C	+70°C	-30°C	+80°C	Dry



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# 5. Electrical Specifications

#### **5.1** Typical Electrical Characteristics

At Ta = 25 °C, 
$$V_{DD}$$
 = 5.0±0.2V,  $V_{SS}$ =0V.

Table 5

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage (Logic)	$V_{DD}$ - $V_{SS}$		4.8	5.0	5.2	V
Supply voltage (LCD)	$V_{LCD} = V_{EE} - V_{SS}$	$V_{DD} = +5.0V$ , Note 1	19.1	19.4	19.7	V
Input signal voltage	$V_{IH}$	"H" level	VDD-2.2	1	VDD	V
Input signal voltage	$V_{IL}$	"L" level	0	1	0.8	V
Output voltage	$V_{OH}$	"H" level	VDD-0.3	I	VDD	V
Output voltage	$\begin{array}{c} \text{ge (Logic)} & V_{\text{DD}}\text{-}V_{\text{SS}} \\ \text{ge (LCD)} & V_{\text{LCD}}\text{=}V_{\text{EE}}\text{-}V_{\text{SS}} \\ \text{voltage} & \frac{V_{\text{IH}}}{V_{\text{IL}}} \\ \text{ge} & \frac{V_{\text{OH}}}{V_{\text{OL}}} \\ \text{nt} & I_{\text{DD}} \\ \end{array}$	"L" level	0	ı	0.3	V
Supply Current (Logic)	$I_{DD}$	Note 1	-	23.0	34.5	mA
Supply voltage for Backlight	$V_{ m LED}$	Forward current=96mA Lv≥400cd/m <sup>2</sup>	3.2	3.5	3.8	V

Note 1: There is tolerance in optimum LCD driving voltage during production and it will be within the specified range.

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# **5.2** Timing Specifications

At Ta = -20 °C To +70 °C,  $V_{DD}$  = 5.0 $\pm$ 0.2V,  $V_{SS}$  = 0V.

Refer to Fig. 2, the bus-timing diagram for MPU Interface Timing

Table 6

Item	Symbol	Test Conditions	Min.	Max.	Unit
C/ D Set Up Time	t <sub>CDS</sub>		100		ns
C/ D Hold Time	t <sub>CDH</sub>		10		ns
CE, RD, WR Pulse Width	$t_{CE}$ , $t_{RD}$ , $t_{WR}$		80		ns
Data Set Up Time	t <sub>DS</sub>		80		ns
Data Hold Time	t <sub>DH</sub>		40		ns
Access Time	t <sub>ACC</sub>			150	ns
Output Hold Time	t <sub>OH</sub>		10	50	ns

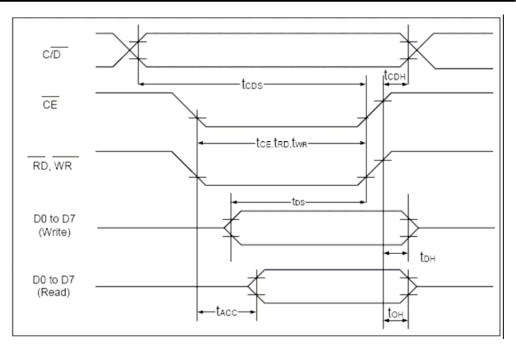


Figure 2: MPU Interface Timing

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At Ta = 0 °C To +50 °C,  $V_{DD}$  = 5.0V±0.2V,  $V_{SS}$  = 0V.

Refer to Fig. 3, the bus-timing diagram for Driver Interface Timing.

Table 7

Item	Symbol	Test Conditions	Min.	Max.	Unit
Operating Frequency	f <sub>SCP</sub>	Ta = -20~70°C		9	MHz
SCP Pulse Width	t <sub>CWH</sub> , t <sub>CWL</sub>		150		ns
SCP Rise/Fall Time	t <sub>r</sub> ,t <sub>f</sub>			30	ns
LP Setup Time	t <sub>LSU</sub>		150	290	ns
LP Hold Time	t <sub>LHD</sub>		5	40	ns
Data Setup Time	t <sub>DSU</sub>		170		ns
Data Hold Time	t <sub>DHD</sub>		80		ns
FR Delay Time	t <sub>d</sub>		0	90	ns
CDATA Setup Time	t <sub>CSU</sub>		450	850	ns
CDATA Hold Time	t <sub>CHD</sub>		450	950	ns

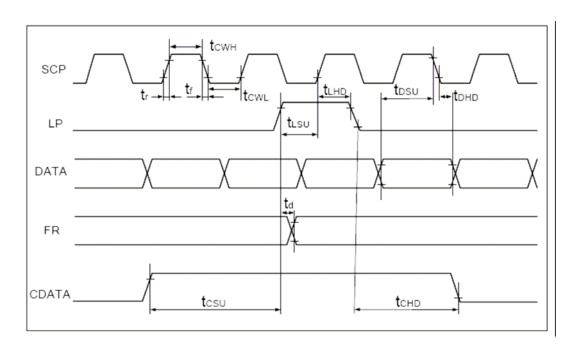


Figure 3: Driver Interface Timing

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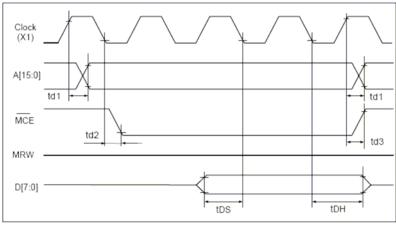
At Ta = 0 °C To +50 °C,  $V_{DD}$  = 5.0V±0.2V,  $V_{SS}$  = 0V.

Refer to Fig. 4 the bus timing diagram for External Memory Interface.

Table 8

ltem	Symbol	Test Conditions	Min.	Max.	Unit
Address Delay Time	t <sub>d1</sub>			250	ns
MCE Fall Delay Time(Read)	t <sub>d2</sub>			180	ns
MCE Rise Delay Time(Read)	t <sub>d3</sub>			180	ns
Data Setup Time	t <sub>DS</sub>				ns
Data Hold Time	t <sub>DH</sub>				ns
MCE Fall Delay Time(Write)	t <sub>d4</sub>			200	ns
MCE Rise Delay Time(Write)	t <sub>d5</sub>			200	ns
MRW Fall Delay Time	t <sub>d6</sub>			180	ns
MRW Rise Delay Time	t <sub>d7</sub>			180	ns
Data Stable Time	t <sub>d8</sub>			450	ns
Data Hold Time	t <sub>d9</sub>			200	ns





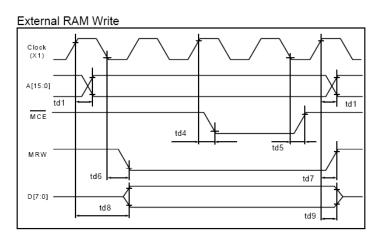


Figure 4: External Memory Interface

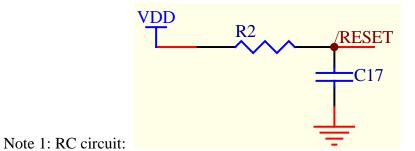
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At Ta = 0 °C To +50 °C,  $V_{DD}$  = 5.0V±0.2V,  $V_{SS}$  = 0V. Refer to <u>Fig. 5</u> the bus timing diagram for reset timing.

Table 9

Item	Symbol	Max.	Тур.	Min.	Unit
Treset	Reset active time	20	-	1	ms
POR (Power-on reset)	There is a RC circuit inside: R2=10K $\Omega$ , C17=1uF (Note 1)	-	-	-	-



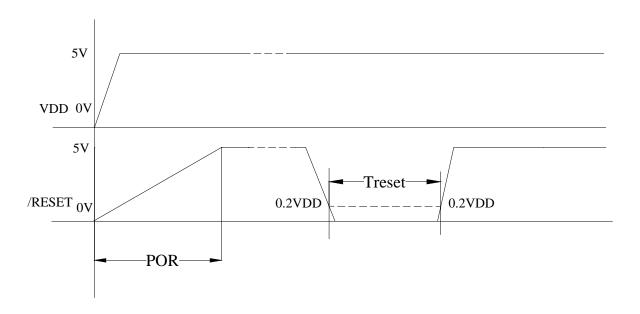


Figure 5: reset timing



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#### 6. Quality Units

#### 6.1.0 Purpose

This standard for quality assurance should define the quality of LCD module products to customer by JINGHUA DISPLAYS LTD.

#### 6.2.0 Scope

This document defines general provisions as well as inspection standards for LCD module supplied by JINGHUA DISPLAYS LTD, except for those with special requirements from customer.

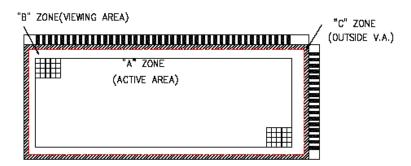
#### 6.3.0 Definition

#### 6.3.1 Definition of area

A Zone: Active area.

B Zone: Viewing area.

C Zone: Outside viewing area.



#### 6.3.2 Definition of size

Large size(L):  $1\sim$ 6 pcs LCD screens are cut out of from each 14 " ×16 " mother glass. Middle size(L):  $7\sim$ 50 pcs LCD screens are cut out of from each 14 " ×16 " unit mother glass. Small size(S): more than 50 pcs LCD screens are cut out of from each 14 " ×16 " unit mother glass.

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#### 6.4.0 Quality Specification

#### 6.4.1 Conditions of Cosmetic Inspection

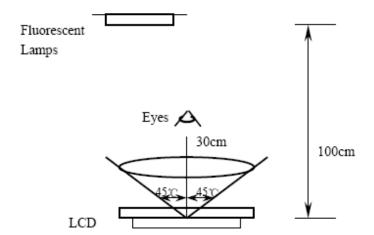
6.4.1.1 Tests should be conducted under the following conditions:

Ambient temperature:  $22\pm5^{\circ}$ C.

Ambient humidity:  $65 \pm 20\%$ RH.

Ambient Luminance: 40-watt fluorescent lamp.

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under fluorescent light. Distance between LCD and fluorescent lamps should be 100 cm or more. Viewing direction for inspection is 45° from vertical against LCD.



6.4.1.2 When test the model of transmissive product must add the reflective plate.

#### 6.4.2 Sampling plan

Unless otherwise agreed in writing, the sampling inspection shall be applied to the incoming inspection of customer.

Lot size: Quantity of shipment lot per model.

Ш Sampling type: Normal inspection, single sampling.

Ш Sampling Level: Level II.

Sampling table: GB/T2828.1. (GB-national standard of China.)



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# 6.4.3 Classification of defects and Acceptable quality level

Defects and classified as either a major or minor defect defined as bellows:

- Major defect: It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
- Minor defect: It is a defect that will not result in functioning problem with deviation classified.

The AQL for major and minor defects is defined as follows:

Partition	Definition	AQL
Major defect	Functional defective as product.	0.4
Minor defect	Satisfy all functions as product but not	1.0
	satisfy cosmetic standard.	1.0

# 6.4.4 Applicable instrument

	_		
	TOD	module	tactor
(Calcal)	1.0.17	moanie	iesiei.

Multimeter.

Caliper.

Defect size filming standard.



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# 6.4.5 Inspection quality criterion

# 6.4.5.1 LCD panel part.

The inspection specification as following list:

Classify	Item	Description of defects	Inspection criterion	Drawing specification
	1. Non-display.	Product no function.	Not accept.	
	2. LCD with wrong view direction.	Difference in Spec.	Not accept.	
	3.Segment missing.	Part or all pattern do not light up.	Not accept.	
	Occur high current.	Current exceed designed value.	Not accept.	
	5. LC leakage.	LC does not fulfill the glass cell.	Not accept.	
Major defect	6. Deviation from drawing.	LCM Dimension difference from drawing and over tolerance	According to dimensions noted in the specification.	
	7. Wrong type applied.	Wrong polarizer attachment.	Not accept.	
		Pin attached wrong type applied.	Not accept.	
	8. Incorrect pins quantity	Pin attached wrong quantity applied.	Not accept.	



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Minor defect	9.Pattern deformation	Segment fatter or smaller.	Accept if c or d≤1/4—1/5W, or refer to the defect specimen.  W= Segment width  Accept if   a-b   ≤1 / 4a, or refer to the defect specimen.  a = Segment width	a b
Minor defect	10. Pinholes	black spot/ white spot at activated state.	1. Large size LCD Accept if can't be found at 1m distance and will not enlarge under electronic test.  2. Middle size LCD Diameter (mm)	O = (X+Y)/2



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			Positive panel:	
			1. A zone.	
			(1) Large size LCD	
			Accept if can't find at 1m distance and	
			will not enlarge under electronic test.	
			(2) Middle size LCD	( )   Y
			Diameter (mm) Accept QTY	<b>∠</b> i_ <b>±</b>
			Ø≤0.15 Not count	— <b>→</b> :
			0.15<Ø≤0.25 3	
			0.25<Ø≤0.35 1	
			Ø>0.35 0	
			(3) Small size LCD	
			Diameter (mm) Accept QTY	
			Ø≤0.15 Not count	
			0.15<Ø≤0.25 2	
			0.25<Ø≤0.30 1	
			Ø>0.30 0	
			2. B zone.	$\emptyset = (X+Y)/2$
			1.5 times of acceptable largest	9 (X+1)/2
			diameter size of Zone A.	
Minor	11.Blemishes and	Black spot/ dust	3. C area	
defect	foreign matters.	on LCD.	Not count.	
	Ü	(non-display)	Negative panel:	
			1. A zone.	
			(1) Large size LCD	
			Diameter (mm) Accept QTY	
			Ø≤0.15 Not count	
			0.15<Ø≤0.30 4	
			0.30<Ø≤0.50 1	
			Ø>0.50 0	
			(2) Middle and small size LCD	
			Diameter (mm) Accept QTY	
			Ø≤0.15 Not count	
			0.15<Ø≤0.25 3	
			Ø>0.25 0	
			2. B zone.	
			1.5 times of acceptable largest	
			diameter size of Zone A.	
			3. C area	
			Not count.	
			The nearest distance allowed between	
			two black spot is 20mm.	
		l .		



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_		<u>'</u>		
Minor defect	12.Black lines and scratches.	Scratch on glass or polarizer surface. And foreign linear matters in LCD.	Positive panel:  1. A zone.  (1) Large size LCD  Accept if can't be found at 1m distance and will not enlarge under electronic test.  (2) Middle size LCD  Diameter (mm) Accept QTY  W = 0.02 Not count  0.02 < W = 0.03, L = 4 2  0.03 < W = 0.05, L = 3 2  0.02 < W = 0.03, L > 4 0  0.03 < W = 0.05, L > 3 0  W > 0.05 As the spot criteria.  (3) small size LCD  Diameter (mm) Accept QTY  W = 0.02 Not count  0.02 < W = 0.03, L = 4 2  0.03 < W = 0.05, L = 2 1  0.02 < W = 0.03, L > 4 0  0.03 < W = 0.05, L > 2 0  W > 0.05 As the spot criteria.  2. B zone.  1.5 times of acceptable largest diameter size of Zone A.  3. C zone  Not count.  Negative panel:  1. A zone.  (1) Large size LCD  Diameter (mm) Accept QTY  W = 0.02 Not count  0.02 < W = 0.03, L = 5 3  0.03 < W = 0.05, L = 2  0.02 < W = 0.03, L = 5 0  0.03 < W = 0.05, L = 4 2  0.02 < W = 0.03, L = 5 0  0.03 < W = 0.05, L = 4 2  0.02 < W = 0.03, L = 5 0  0.03 < W = 0.05, L = 4 2  0.02 < W = 0.03, L = 5 0  0.03 < W = 0.05, L = 4 2  0.02 < W = 0.03, L = 4 2  0.02 < W = 0.03, L = 5 0  0.03 < W = 0.05, L = 4 2  0.02 < W = 0.03, L = 4 2  0.03 < W = 0.05, L = 2 2  0.02 < W = 0.03, L = 4 2  0.03 < W = 0.05, L = 2 2  0.02 < W = 0.03, L = 2 2  0.03 < W = 0.05, L = 2 2  0.03 < W = 0.05, L = 2 2  0.03 < W = 0.05, L = 2 0  W > 0.05 As the spot criteria.	



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Minor defect	Black lines and scratches.	Scratch on glass or polarizer surface. And foreign linear matters in LCD.	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	
Minor defect	13.Scratch on PI coating.	PI coating scratched.	The nearest distance allowed between two defects is 20mm.  The visible scratch of A zone can not be accepted at 30cm view distance.	
Minor defect	14.Rainbow	Arches, circular or parallel colorful spread.	According to the limit specimen.	
Minor defect	15.Bubbles or wrinkles in polarizer	Bubbles or wrinkles between polarizer and glass.	A zone : The visible defect can not be accepted at 30cm view distance.  B zone : Not count.	
Minor defect	16.Position of polarizer attachment	16. Wrong polarizer attachment in position or dimension.	Polarizer protruding from edge of glass and exceeding/ within the maximum external dimension of LCD.	
Minor defect	17. Ink printing defect	17.1 Ink line/ pattern broken	Not accept.	
		17.2 Ink pattern/ line jagged.	Accept if the thick or thin part is less than or equal to 25% segment width ,or according to the limit specimen.	



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		16.1 Wrong		
Minor	16.Position of	polarizer	Polarizer protruding from edge of glass	
defect	polarizer attachment	attachment in position or	and exceeding/ within the maximum external dimension of LCD.	
	attacimicit	dimension.	CACHAI GIRCISION OF DOD.	
		17.1 Ink line/	Not accept.	
		pattern broken	ног ассерг.	
Minor defect		17.2 Ink pattem/ line jagged.	Accept if the thick or thin part is less than or equal to 25% segment width or according to the limit specimen.	
			When activated with current white light	
	17. Ink printing defect	17.3 Light leakage	appears in the position of pinhole or scratch due to ink printing	
		Digiti reatinge	misalignment. According to the pinhole specification.	
Minor defect		17.4 Ink printing pattern/line uneven	Reject if the thick or thin is more than 1/2W. Reject when W1—W2≤1/3W.	w <sub>1</sub> w <sub>2</sub> <b>0</b>
Minor defect		18.1 Corrosion or foreign material on terminal legs.	Pin incoming defect: oxidized, damage (including pins plating damaged), excess epoxy on bottom glass or terminal legs. Not accept.	
Minor defect	18. Pin defect.	18.2 Pin deviation over tolerance	According to the specification.	



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				а	ь	с	Accept QTY				
			19.1 Chip in	a≤3mm (L≥5mm)	b≤1/2W	c≪T	2	I.T.O electrode			
Minor defect	19. Chipp on co		lead contact area.	a < 1/2L (L < 5mm)	b≤1/2W	c≪T	2				
				a	b	c	Accept QTY				
			19.2 Others		1/2 width of eal	c≪T	2				
Minor	20.61	'			b	с	Accept QTY				
defect	20.Glass chip on 6		eage	a≤3mm	not exceed 1/2 width of seal	c≤3/4T	2	, de			
				a	b	с	Accept QTY				
Minor defect	21. Chipped	21.1 Glass pped chip ctrode on	21. Glass	21. Glass	21. Glass	COG and TAB product.	a≤2mm (and not exceed 3 ITO terminal)	b≤W/5	T>0.7mm c≤1/2T. T≤0.7mm c≤T.	2	b c
	electrode pad			a	b	с	Accept QTY				
Minor defect			Others	a≤3mm (and not exceed 4 ITO terminal)	b≤W/4	c≪T	2				



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		21.2	COG and	a	b	c T>0.7mm c≤1/2T.	Accept QTY	b b	
Minor defect		Glass chip on	-	a≤3mm	b≤W/4	T≤0.7mm c≤T.	2	e e	
		ITO back	Others	a	ь	c	Accept QTY		
			Oulers	a≤5mm	b≤W/4	c≤T	2		
	Minor 22.Mechanical defect damage.		Extended crack inspector shall		В	Accept	QTY		
			attempt to remove the chip with tweezers, re-evaluate if the remaining defect is still a	b≤1/5W		2		0 1	
Minor defect	crack or a chip.		Not accept						

#### Remark:

The minimum space between any 2 defects (spot, dirt) should more than 20mm, and Max. allowed defect QTY in total:

 $\begin{array}{lll} Large\ size\ LCD: & Zone\ A:\leqslant 5/unit,\ Zone\ B\leqslant 5/unit;\\ Middle\ size\ LCD: & Zone\ A:\leqslant 3/unit,\ Zone\ B\leqslant 3/unit;\\ Small\ size\ LCD: & Zone\ A:\leqslant 2/unit,\ Zone\ B\leqslant 2/unit. \end{array}$ 



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# **6.4.5.2** Other part

The inspection specification as following list:

	inspection specification	and to rollowing not	
NO	Items	Criterion of defects	AQL
1	Backlight	1.Lumination source flickers.     2.Using spot, lines and contamination standard of LCD to judge the spots or scratches defect on backlight.     3.Not allow unlighted on backlight.     4.Colour and luminance of backlight should correspond its specification.	Major Minor Major Major
2	PCB, COB	<ol> <li>1.COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>2.COB seal surface may not have pinholes through to the IC.</li> <li>3.The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>4.Beyond 2mm of the seal area, there may not have sealant on the PCB.</li> <li>5.No oxidation or contamination on PCB connector.</li> <li>6.Parts on PCB should correspond the characteristic, and not allow wrong parts, missing parts or additional parts.</li> <li>7.The jumper on the PCB should correspond to the characteristic.</li> <li>8.The solder which gets on bezel, LED pad, zebra pad or screw hole pad should be smoothed down.</li> </ol>	Minor Minor Major Minor Major Minor Major
3	Soldering	1.No unmelted solder pastes on the PCB.     2.No cold solder joints, solder connection missing, oxidation of solder.     3.No short circuits in components on PCB.	Minor Minor Minor
4	General Appearance	<ol> <li>No oxidation, contamination, curves ,cracks or bends on interface Pin of TCP.</li> <li>No solder residue or solder balls on product.</li> <li>The IC on the TCP may not be damaged.</li> <li>The residual rosin or tin oil of soldering (component or chip component) is not turned into brown or black color.</li> <li>Packing method correspond the specification.</li> <li>Dimension and structure correspond the specification sheet.</li> <li>No dirt and break on the heat seal.</li> </ol>	Minor Minor Major Minor Major Major Major Major



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# 6.5.0 Reliability

The LCD module should not fail the following reliability test.

·			
ITEM	Condition		Criterion
High temperature operation	+70°C 8h		1.Total current consumption should be below double of initial value. 2.Cosmetic defects should not be happened.
Low temperature operation	-20°C 8h		
Humidity	Storage	40°C 93%RH 24h	-
	Operation	40℃ 93%RH 8h	
High temperature storage	+80°C 10h		
Low temperature storage	-30°C 10h		
Thermal shock storage	-20°C→+70°C 60min→60min 5 cycle		
Vibration (Package state)	50Hz 0.7mm 30min in each direction (X, Y, Z).		
Falling test (Packaged state)	Weight≥15kg; Falling height: 80cm. Weight<15kg; Falling height: 100cm.		



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#### 6.6.Quality Assurance

6.6.1 JINGHUA DISPLAYS will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with the LCM specification, for a period of one year from the date of shipment. Confirmation of such date shall be based on freight documents.

No warranty can be granted if any of the precautions stated in handing LCD and LCD Modules above have been disregarded.

**6.6.2** In returning the LCD and LCD Modules, they must be properly packaged and there should be detailed description of the failures or defects. Broken glass, scratches on polarizers, mechanical damages as well as defects that are caused by accelerated environmental tests are excluded from warranty.

#### 6.7. Precautions in Use of LCM

- 1. Handling of LCM
  - 1.1 Don't give external shock.
  - 1.2 Liquid crystal is chemical hazardous substance. Once the liquid crystal inside it leaks out, be sure not to get any in your mouth. If the liquid is adhered your skin or clothes etc, wash it off using soap and water thoroughly and immediately.
  - 1.3 Don't apply excessive force on the display surface.
  - 1.4 Don't scratch and dirty polarizer of covering the display surface of the LCD module.
  - 1.5 In order to prevent static electricity from destructing, be sure to ware gauntlet that is tested up to grade.
- Storage
  - 2.1 Store in dark places and do not expose to sunlight or fluorescent light. Keep the temperature between 0°C and 40°C and the humidity lower than 60%RH. Please consult JINGHUA DISPLAYS LTD. for other storage requirements.
  - 2.2 Storage in a clean environment, free-dust and well ventilated.
  - 2.3 Storage in anti-static electricity container.
- Soldering
  - 3.1 The soldering temperature is 260+5°C and soldering Time should be less than 3 sec,and soldering iron power should be less than 30w.
  - 3.2 Re-soldering: no more than 3 times.
  - 3.3 The soldering point should be further than 1.6 mm from body.

"Shenzhen Jinghua Displays CO.,LTD. reserves the right to change this specification"